

**N-Ch MOSFET** 

## **General Description**

The WSG03N10 is the highest performance trench N-Ch MOSFET with extreme high cell density, which provide excellent RDSON and gate charge for most of the small power switching and load switch applications.

The WSG03N10 meet the RoHS and Green Product requirement with full function reliability approved.

#### **Features**

- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent Cdv/dt effect decline
- Green Device Available

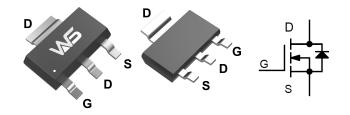
## **Product Summery**

BVDSS	RDSON	ID
100V	90mΩ	4.8A

## **Applications**

Power Management in TV Inverter.

## **SOT-223 Pin Configuration**



## **Absolute Maximum Ratings**

Symbol	Parameter	Rating	Units	
$V_{DS}$	Drain-Source Voltage	100	V	
$V_{GS}$	Gate-Source Voltage	±20	V	
I <sub>D</sub> @T <sub>c</sub> =25℃	Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup>	4.8	А	
I <sub>D</sub> @T <sub>c</sub> =70°C	Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup>	3.4	Α	
I <sub>DM</sub>	Pulsed Drain Current <sup>2</sup>	16	Α	
P <sub>D</sub> @T <sub>A</sub> =25℃	Total Power Dissipation <sup>3</sup>	3.5	W	
T <sub>STG</sub>	Storage Temperature Range -55 to 150		$^{\circ}$	
$T_J$	Operating Junction Temperature Range -55 to 150		$^{\circ}$ C	

### **Thermal Data**

Symbol	Parameter	Тур.	Max.	Unit
R <sub>0JA</sub>	Thermal Resistance Junction-ambient <sup>1</sup>		70	°C/W
$R_{ heta JC}$	Thermal Resistance Junction-Case <sup>1</sup>		30	°C/W



# Electrical Characteristics (T<sub>J</sub>=25 °C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V , I <sub>D</sub> =250uA	100			V
$\triangle BV_{DSS}/\triangle T_{J}$	BVDSS Temperature Coefficient	Reference to 25℃ , I <sub>D</sub> =1mA		0.098		V/℃
R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance <sup>2</sup>	V <sub>GS</sub> =10V , I <sub>D</sub> =4A		90	100	mΩ
		V <sub>GS</sub> =4.5V , I <sub>D</sub> =3.5A		100	150	mΩ
$V_{GS(th)}$	Gate Threshold Voltage	\/ -\/   -250uA	1	2	3	V
$\triangle V_{GS(th)}$	V <sub>GS(th)</sub> Temperature Coefficient	$V_{GS}=V_{DS}$ , $I_D=250uA$		-4.57		mV/℃
I <sub>DSS</sub>	Drain-Source Leakage Current	V <sub>DS</sub> =80V , V <sub>GS</sub> =0V , T <sub>J</sub> =25℃			1	
		V <sub>DS</sub> =80V , V <sub>GS</sub> =0V , T <sub>J</sub> =55℃			5	uA
I <sub>GSS</sub>	Gate-Source Leakage Current	$V_{GS}$ = $\pm 20V$ , $V_{DS}$ = $0V$			±100	nA
gfs	Forward Transconductance	V <sub>DS</sub> =5V , I <sub>D</sub> =2A		15		S
Rg	Gate Resistance	V <sub>DS</sub> =0V , V <sub>GS</sub> =0V , f=1MHz		2.5		Ω
$Q_g$	Total Gate Charge (10V)	V <sub>DS</sub> =30V , V <sub>GS</sub> =10V , I <sub>D</sub> =4A		16	23	
$Q_gs$	Gate-Source Charge			2.5		nC
Q <sub>gd</sub>	Gate-Drain Charge			3		
$T_{d(on)}$	Turn-On Delay Time	$V_{DD}$ =30V , $V_{GEN}$ =10V , $R_{G}$ =6 $\Omega$ $I_{D}$ =1A , $R_{L}$ =30 $\Omega$		11	20	
Tr	Rise Time			6	11	
T <sub>d(off)</sub>	Turn-Off Delay Time			27	49	ns
T <sub>f</sub>	Fall Time			5	10	
Ciss	Input Capacitance	V <sub>DS</sub> =30V , V <sub>GS</sub> =0V , f=1MHz		740	960	
C <sub>oss</sub>	Output Capacitance			47		pF
C <sub>rss</sub>	Reverse Transfer Capacitance			25		

## **Diode Characteristics**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Is	Continuous Source Current <sup>1,4</sup>	V <sub>G</sub> =V <sub>D</sub> =0V , Force Current			3	Α
I <sub>SM</sub>	Pulsed Source Current <sup>2,4</sup>				16	Α
V <sub>SD</sub>	Diode Forward Voltage <sup>2</sup>	V <sub>GS</sub> =0V , I <sub>S</sub> =3A , T <sub>J</sub> =25°C			1.3	V
t <sub>rr</sub>	Reverse Recovery Time	-lF=3A,dI/dt=100A/μs , T <sub>J</sub> =25℃		27		nS
Q <sub>rr</sub>	Reverse Recovery Charge			36		nC

## Note:

- 1. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper, t≦10sec.
- 2.The data tested by pulsed , pulse width  $\,\leq\,300\text{us}$  , duty cycle  $\,\leq\,2\%$
- 3.The power dissipation is limited by 150  $^{\circ}\mathrm{C}$  junction temperature
- 4. The data is theoretically the same as  $I_D$  and  $I_{DM}$ , in real applications, should be limited by total power dissipation.



**N-Ch MOSFET** 

# **Typical Characteristics**

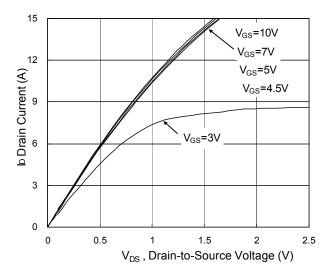


Fig.1 Typical Output Characteristics

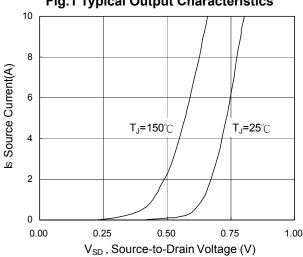


Fig.3 Forward Characteristics Of Reverse

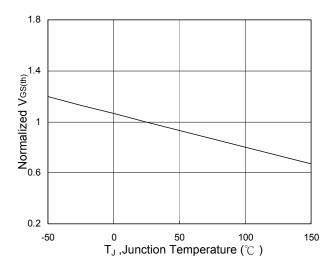


Fig.5 Normalized  $V_{GS(th)}$  vs.  $T_J$ 

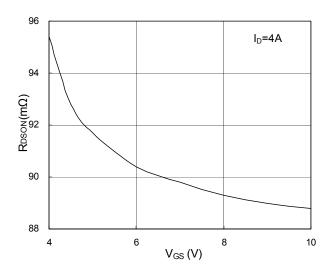


Fig.2 On-Resistance vs. Gate-Source

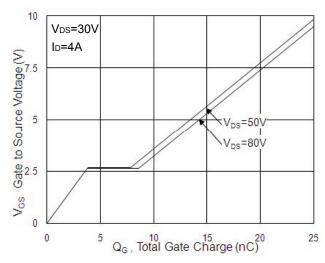


Fig.4 Gate-Charge Characteristics

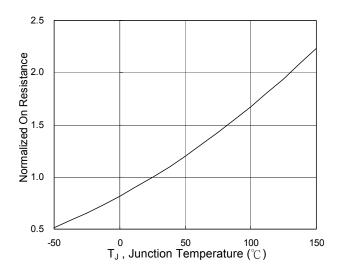
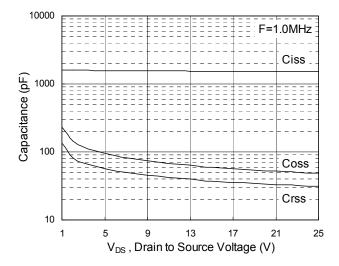


Fig.6 Normalized R<sub>DSON</sub> vs. T<sub>J</sub>





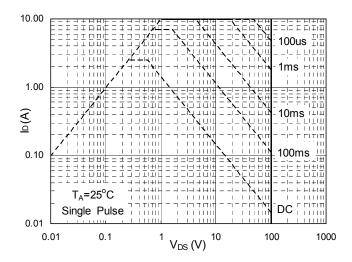


Fig.7 Capacitance

Fig.8 Safe Operating Area

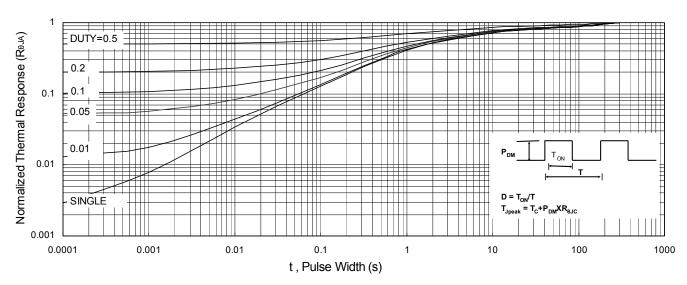


Fig.9 Normalized Maximum Transient Thermal Impedance

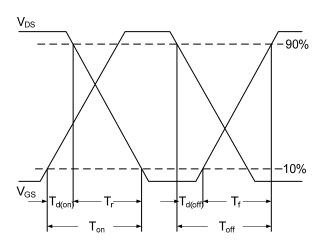


Fig.10 Switching Time Waveform

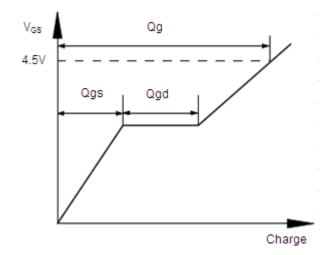


Fig.11 Gate Charge Waveform



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